Notification Number: 202		20211004000		Notification Da			ate:	Oct 13, 2021	
Title: DLPC34XX/DLPC150 Marking Change									
Customer Contact: dlp-pcn-tea		cn-team@	am@list.ti.com		Dept:		Quality Services		
Change Type:									
Assembly Site			Design			Wafer Bump Site			
Assembly Process			Data Sheet			Wafer Bump Material			
Assembly Materials			Part number change			Wafer Bump Process			
Mechanical Specification			Test Site			Wafer Fab Site			
Packing/Shipping/Labeling			Test Process			Wafer Fab Materials			
						Waf	er Fab I	Process	

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification related to device marking. The fourth row of the marking will be changing from the wafer fab lot number to the standard 7-character TI Assembly Lot Trace Code format.

Reason for Change:

Improved traceability

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): None

Changes to product identification resulting from this notification:

The fourth row of the marking is changing from the wafer fab lot number to the standard 7character TI Assembly Lot Trace Code format. Below pictures show an example of a DLPC3436CZVB before and after the change:



Before Change – 4th row "N3UX99.00" shows wafer fab lot number



After Change – 4th row "17Z02XS" shows standard TI assembly Lot Trace Code

Product Affected:

DLPC150ZEZ, DLPC3430CZVBR, DLPC3432CZVB, DLPC3433CZVB, DLPC3434CZVB, DLPC3435CZEZ, DLPC3436CZVB, DLPC3437CZEZ, DLPC3438CZEZ, DLPC3439CZEZ, DLPC3440CZEZ, DLPC3470CZEZ, DLPC3478CZEZ, DLPC3479CZEZ

As of early October, 2021, new production DLPC3436CZVB and DLPC3439CZEZ will have this marking change. The marking change will be fanned out to the other devices in the coming months. TI will update the next revisions of datasheets with the new row 4 marking during upcoming datasheet revisions. There is currently no schedule available for such datasheet updates.

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
TI DLP PCN Team	dlp-pcn-team@list.ti.com
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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